



## TPS65980 Thunderbolt™ 总线电源降压/升压

### 1 特性

- 由 Thunderbolt™ 总线供电
- 2.5V 至 15.75V 输入
- 3.3V 输出
- 电缆电源输出电流限制
- 热关断

### 2 应用范围

- Thunderbolt™/Thunderbolt™ 2 系统
- 总线供电系统
- 电源管理系统

### 3 说明

TPS65980 是一款直流/直流开关稳压器，此稳压器由电压范围介于 2.5V 至 15.75V 之间的 Thunderbolt™ 或 Thunderbolt™ 2 电源总线供电，并且生成 3 个独立 3.3V 电源输出。

TBT\_OUT 电源为本地外设 Thunderbolt™ 控制器和支持电路供电。CBL\_OUT 电源将电能输送回 Thunderbolt™ 电缆，并且具有可调电流限值。

DEV\_OUT 电源为器件中的所有其他电路供电来执行其设计的功能。

TPS65980 采用 24 引脚

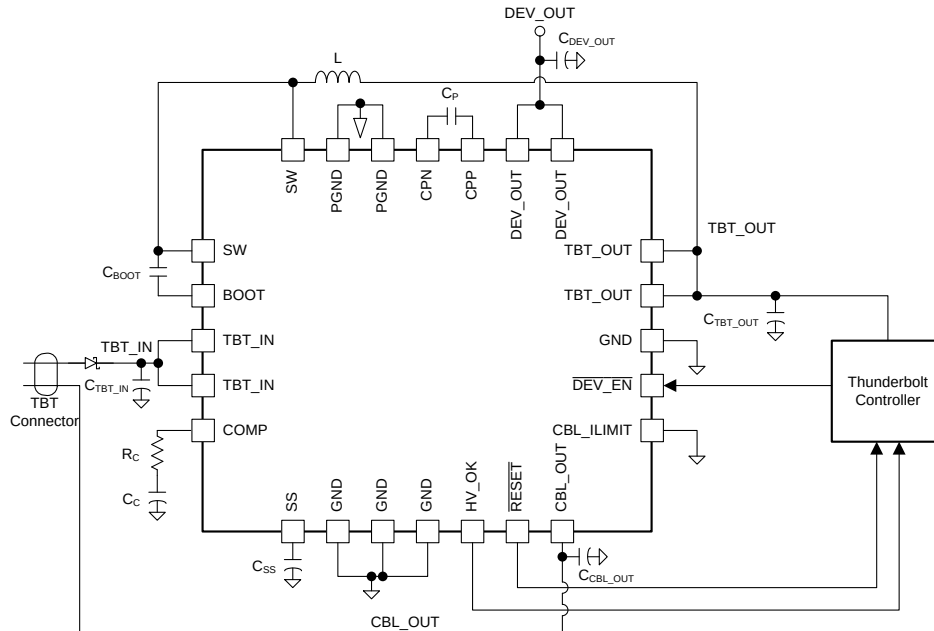
5mm x 4mm x 0.9mm 超薄四方平面无引线 (VQFN) 封装。

器件信息<sup>(1)</sup>

| 器件名称     | 封装        | 封装尺寸      |
|----------|-----------|-----------|
| TPS65980 | VQFN (24) | 5mm x 4mm |

(1) 要了解所有可用封装，请见数据表末尾的可订购产品附录。

### 4 简化电路原理图



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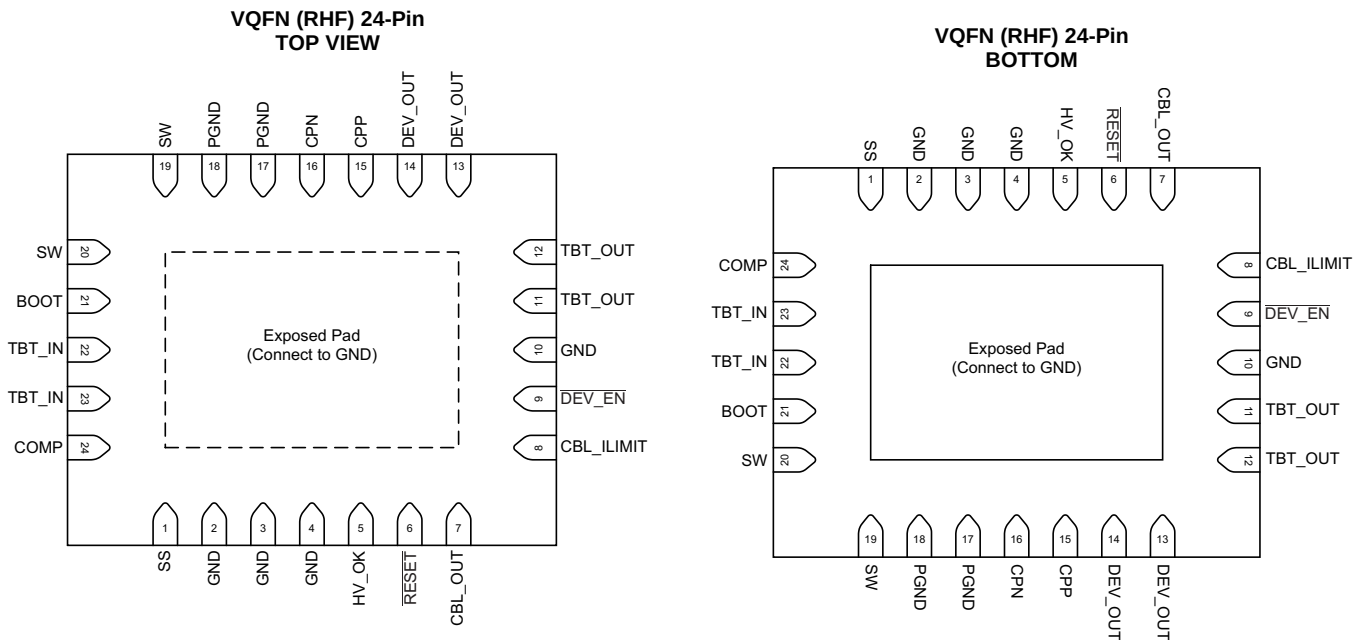
## 5 修订历史记录

### Changes from Original (April 2014) to Revision A

Page

|                     |   |
|---------------------|---|
| • 已将文档修改为完整版。 ..... | 1 |
|---------------------|---|

## 6 Pin Configuration and Functions



### Pin Functions

| PIN     |                             | I/O    | DESCRIPTION                                                                                                                                                                                                                         |
|---------|-----------------------------|--------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NO.     | NAME                        |        |                                                                                                                                                                                                                                     |
| 1       | SS                          | ANALOG | Soft Start Capacitance. This pin sets the soft start ramp rate when the TBT_IN voltage ramps from 0V to high voltage.                                                                                                               |
| 2, 3, 4 | GND                         | GND    | Device Ground                                                                                                                                                                                                                       |
| 5       | HV_OK                       | OUTPUT | High Voltage Present Indicator. This pin indicates that a high voltage is present on TBT_IN. The output asserts high when the TBT_IN pin is above the $V_{HVT}$ voltage and the $\overline{\text{RESET}}$ output is asserting high. |
| 6       | $\overline{\text{RESET}}$   | OUTPUT | Reset output indicator. This pin asserts low when TBT_OUT is in under-voltage.                                                                                                                                                      |
| 7       | CBL_OUT                     | PWROUT | Current Limited Power Output to Thunderbolt™ Cable. This pin supplies power to the Thunderbolt™ cable. The current limit of this pin is set by the CBL_ILIMIT pin.                                                                  |
| 8       | CBL_ILIMIT                  | INPUT  | Current Limit Set. Logic input that sets the current limit state on the CBL_OUT pin. Tie pin to TBT_OUT for a logic high input.                                                                                                     |
| 9       | $\overline{\text{DEV\_EN}}$ | INPUT  | Device Enable Input. When input pin is high, DEV_OUT is high impedance. When input pin low, DEV_OUT is connected to TBT_OUT.                                                                                                        |
| 10      | GND                         | ANALOG | Device Ground                                                                                                                                                                                                                       |
| 11, 12  | TBT_OUT                     | PWROUT | Power Output to Thunderbolt™ circuitry. This pin supplies power to the Thunderbolt™ controller.                                                                                                                                     |
| 13, 14  | DEV_OUT                     | PWROUT | Power Output to peripheral device. This pin supplies power to circuitry not associated with the Thunderbolt™ controller or the Thunderbolt™ cable. It is intended to supply power to the peripheral device main function.           |
| 15      | CPP                         | ANALOG | Charge Pump Capacitance Positive Output                                                                                                                                                                                             |
| 16      | CPN                         | ANALOG | Charge Pump Capacitance Negative Output                                                                                                                                                                                             |
| 17, 18  | PGND                        | GND    | Buck Controller Power Ground                                                                                                                                                                                                        |
| 19, 20  | SW                          | ANALOG | Buck Controller Switch Output                                                                                                                                                                                                       |
| 21      | BOOT                        | ANALOG | Buck Controller Bootstrap                                                                                                                                                                                                           |
| 22, 23  | TBT_IN                      | PWRIN  | Power Input from Thunderbolt™ Cable. This pin is the power supply to the device.                                                                                                                                                    |
| 24      | COMP                        | ANALOG | Buck Converter Compensation. This pin provides compensation to the buck converter feedback loop.                                                                                                                                    |

## 7 Specifications

### 7.1 Absolute Maximum Ratings

over operating free-air temperature (unless otherwise noted)<sup>(1)</sup>

|                                     |                                 | MIN  | MAX | UNIT |
|-------------------------------------|---------------------------------|------|-----|------|
| Input voltage range <sup>(2)</sup>  | TBT_IN                          | −0.3 | 18  | V    |
|                                     | DEV_EN                          | −0.3 | 3.6 |      |
|                                     | BOOT                            | −0.3 | 25  |      |
|                                     | BOOT (10 ns transient)          | −0.3 | 27  |      |
|                                     | BOOT (vs SW)                    | −0.3 | 7   |      |
|                                     | SW                              | −0.6 | 18  |      |
|                                     | SW (10 ns transient)            | −2   | 20  |      |
|                                     | COMP                            | −0.3 | 3.6 |      |
|                                     | SS                              | −0.3 | 3.6 |      |
|                                     | CBL_ILIMIT                      | −0.3 | 3.6 |      |
|                                     | CPP                             | −0.3 | 7.2 |      |
|                                     | CPN                             | −0.3 | 3.6 |      |
| Output voltage range <sup>(2)</sup> | TBT_OUT, CBL_OUT, DEV_OUT       | −0.3 | 3.6 | V    |
|                                     | RESET, HV_OK                    | −0.3 | 3.6 |      |
| V <sub>diff</sub>                   | Voltage from GND to Thermal Pad | −0.2 | 0.2 | V    |
|                                     | Voltage from PGND to GND        | −0.2 | 0.2 | V    |
| T <sub>A</sub>                      | Operating ambient temperature   | −40  | 85  | °C   |
| T <sub>J</sub>                      | Operating junction temperature  | −40  | 125 | °C   |

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltage values are with respect to network ground pin.

### 7.2 Handling Ratings

|                    |                           |                                                                                          | MIN | MAX | UNIT |
|--------------------|---------------------------|------------------------------------------------------------------------------------------|-----|-----|------|
| T <sub>stg</sub>   | Storage temperature range |                                                                                          | −55 | 150 | °C   |
| V <sub>(ESD)</sub> | Electrostatic discharge   | Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins <sup>(1)</sup>              | 0   | 2   | kV   |
|                    |                           | Charged device model (CDM), per JEDEC specification JESD22-C101, all pins <sup>(2)</sup> | 0   | 500 | V    |

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### 7.3 Recommended Operating Conditions

over operating free-air temperature (unless otherwise noted)

|                |                                |                           | MIN  | MAX   | UNIT |
|----------------|--------------------------------|---------------------------|------|-------|------|
| TBT_IN         | Supply input voltage range     |                           | 2.5  | 15.75 |      |
| V <sub>I</sub> | Input voltage range            | DEV_EN                    | –0.1 | 3.6   | V    |
|                |                                | BOOT                      | –0.1 | 25    |      |
|                |                                | SW                        | –0.6 | 16.5  |      |
|                |                                | COMP                      | –0.1 | 3.6   |      |
|                |                                | SS                        | –0.1 | 3.6   |      |
|                |                                | CBL_ILIMIT                | –0.1 | 3.6   |      |
|                |                                | CPP                       | –0.1 | 7.2   |      |
|                |                                | CPN                       | –0.1 | 3.6   |      |
| V <sub>O</sub> | Output voltage range           | TBT_OUT, CBL_OUT, DEV_OUT | –0.1 | 3.6   | V    |
|                |                                | RESET, HV_OK              | –0.1 | 3.6   |      |
| T <sub>A</sub> | Operating free-air temperature |                           | –40  | 85    | °C   |
| T <sub>J</sub> | Operating junction temperature |                           | –40  | 125   | °C   |

### 7.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |                                              | TPS65980 | UNIT |
|-------------------------------|----------------------------------------------|----------|------|
|                               |                                              | RHF      |      |
|                               |                                              | 24 PIN   |      |
| R <sub>θJA</sub>              | Junction-to-ambient thermal resistance       | 30.1     | °C/W |
| R <sub>θJC(top)</sub>         | Junction-to-case (top) thermal resistance    | 26.9     |      |
| R <sub>θJB</sub>              | Junction-to-board thermal resistance         | 8.2      |      |
| Ψ <sub>JT</sub>               | Junction-to-top characterization parameter   | 0.3      |      |
| Ψ <sub>JB</sub>               | Junction-to-board characterization parameter | 8.2      |      |
| R <sub>θJC(bot)</sub>         | Junction-to-case (bottom) thermal resistance | 1.5      |      |

(1) For more information about traditional and new thermal metrics, see the *IC Package Thermal Metrics* application report, [SPRA953](#).

## 7.5 Electrical Characteristics

Unless otherwise noted all specifications applies over the  $V_{TBT\_IN}$  range and operating ambient temperature of  $-40^{\circ}\text{C} \leq T_A \leq 85^{\circ}\text{C}$ ,  $C_{TBT\_IN} = 22\ \mu\text{F}$ ,  $C_{TBT\_OUT} = 10\ \mu\text{F}$ ,  $C_{CBL\_OUT} = 1\ \mu\text{F}$ ,  $CSS = 10\ \text{nF}$ , and  $33\ \text{V}/\mu\text{s}$  logic input transitions. Typical values are for  $V_{TBT\_IN} = 12\ \text{V}$  and  $T_A = 25^{\circ}\text{C}$ .

| PARAMETER                                                           |                                                 | TEST CONDITIONS | MIN                                                         | TYP  | MAX   | UNIT |
|---------------------------------------------------------------------|-------------------------------------------------|-----------------|-------------------------------------------------------------|------|-------|------|
| POWER SUPPLIES AND CURRENTS                                         |                                                 |                 |                                                             |      |       |      |
| V <sub>TBT_IN</sub>                                                 | TBT_IN Input voltage range                      |                 | 2.5                                                         | 12   | 15.75 | V    |
| V <sub>REF_RSTN</sub>                                               | TBT_OUT to $\overline{\text{RESET}}$ clear high |                 | 3                                                           | 3.1  | 3.2   | V    |
|                                                                     | TBT_OUT to $\overline{\text{RESET}}$ assert low |                 | 2.5                                                         | 2.6  | 2.7   |      |
| V <sub>HVTR</sub>                                                   | TBT_IN to HV_OK assert                          |                 | 4.36                                                        | 4.5  | 4.64  | V    |
| V <sub>HVTHYST</sub>                                                | TBT_IN to HV_OK clear                           |                 | 100                                                         |      |       | mV   |
| SR <sub>02L</sub>                                                   | TBT_IN Input slew rate                          |                 | 0.1                                                         |      |       | 30   |
| SR <sub>L2H</sub>                                                   | TBT_IN Input slew rate                          |                 | 0.1                                                         |      |       | 30   |
| I <sub>RAMP</sub>                                                   | Combined output di/dt <sup>(1)</sup>            |                 |                                                             |      |       | 5    |
| Efficiency                                                          | Buck converter efficiency                       |                 | I <sub>LOADTOTAL</sub> = 3 A, V <sub>TBT_IN</sub> = 12 V    |      |       | 87%  |
|                                                                     | Charge pump efficiency                          |                 | V <sub>TBT_IN</sub> = 3.3 V, I <sub>LOADTOTAL</sub> = 25 mA |      |       | 47%  |
| POWER OUTPUT PINS (LOW VOLTAGE INPUT) <sup>(2)</sup>                |                                                 |                 |                                                             |      |       |      |
| V <sub>TBT_IN</sub>                                                 | TBT_IN Input voltage range                      |                 | 2.5                                                         | 3.3  | 3.4   | V    |
| V <sub>TBT_OUT</sub>                                                | TBT_OUT Output voltage range <sup>(3)</sup>     |                 | 3.135                                                       | 3.25 | 3.4   | V    |
| I <sub>TBT_OUT</sub>                                                | TBT_OUT Load current <sup>(4)(5)</sup>          |                 | $\overline{\text{RESET}}$ high                              |      |       | 50   |
|                                                                     |                                                 |                 | $\overline{\text{RESET}}$ low                               |      |       | 100  |
| POWER OUTPUT PINS (HIGH VOLTAGE INPUT) <sup>(6)</sup>               |                                                 |                 |                                                             |      |       |      |
| V <sub>TBT_IN</sub>                                                 | TBT_IN Input voltage range                      |                 | 10                                                          | 12   | 15.75 | V    |
| V <sub>TBT_OUT</sub>                                                | TBT_OUT Output voltage range <sup>(3)</sup>     |                 | I <sub>LOADTOTAL</sub> = 1 A to 3.5 A                       |      |       | V    |
|                                                                     |                                                 |                 | I <sub>LOADTOTAL</sub> = 0.235 A to 3.5 A                   |      |       |      |
| I <sub>TBT_OUT</sub>                                                | TBT_OUT Load current <sup>(4)</sup>             |                 | 235                                                         |      | 1000  | mA   |
| V <sub>CBL_OUT</sub>                                                | CBL_OUT Output voltage range <sup>(3)</sup>     |                 | ILIMIT = 0, I <sub>CBL_OUT</sub> = 0 to 720 mA              |      |       | V    |
|                                                                     |                                                 |                 | ILIMIT = 1, I <sub>CBL_OUT</sub> = 0 to 1.44 A              |      |       |      |
| V <sub>DEV_OUT</sub>                                                | DEV_OUT Output Voltage Range                    |                 | 3                                                           | 3.27 | 3.319 | V    |
| POWER OUTPUT PINS (HIGH VOLTAGE INPUT DURING SYSTEM SLEEP)          |                                                 |                 |                                                             |      |       |      |
| V <sub>TBT_IN</sub>                                                 | TBT_IN Input voltage range                      |                 | 5.2                                                         | 12   | 15.75 | V    |
| V <sub>TBT_OUT</sub>                                                | TBT_OUT DC Output voltage range                 |                 | I <sub>LOADTOTAL</sub> = 1 A to 3.5 A                       |      |       | V    |
|                                                                     |                                                 |                 | I <sub>LOADTOTAL</sub> = 0.235 A to 3.5 A                   |      |       |      |
| I <sub>TBT_OUT</sub>                                                | TBT_OUT Load current                            |                 | 5                                                           |      | 31    | mA   |
| V <sub>CBL_OUT</sub>                                                | CBL_OUT Output voltage range <sup>(3)</sup>     |                 | 3.171                                                       | 3.27 | 3.319 | V    |
| V <sub>DEV_OUT</sub>                                                | DEV_OUT Output voltage range                    |                 | 3                                                           | 3.3  | 3.319 | V    |
| CABLE OUTPUT (HIGH VOLTAGE INPUT & HIGH VOLTAGE INPUT DURING SLEEP) |                                                 |                 |                                                             |      |       |      |
| V <sub>CBL_OUT_MON</sub>                                            | CBL_OUT Ramp-up monotonicity <sup>(7)</sup>     |                 | CBL_OUT ramp from off to on                                 |      |       | 0    |
| V <sub>CBL_OUT_RIP</sub>                                            | CBL_OUT Voltage ripple                          |                 | After settling<br>All output combined Load > 1 mA           |      |       | 2    |
|                                                                     |                                                 |                 | All output combined Load < 1 mA                             |      |       | 40   |
| I <sub>LIM_CBLOUT</sub>                                             | CBL_OUT Current limit                           |                 | ILIMIT = 0                                                  |      |       | 1.4  |
|                                                                     |                                                 |                 | ILIMIT = 1                                                  |      |       | 2.8  |
| t <sub>LIM_CBLOUT</sub>                                             | Short circuit response time                     |                 | RCBL_OUT = 0.5 Ω to GND, ILIMIT = 0                         |      |       | 500  |
|                                                                     |                                                 |                 | RCBL_OUT = 0.01 Ω to GND, ILIMIT = 0                        |      |       | 8    |

- The three voltage outputs (TBT\_OUT, CBL\_OUT, DEV\_OUT) all pull current from a single node. Therefore, the total combined current cannot exceed the maximum di/dt.
- CBL\_OUT and DEV\_OUT are open (high impedance) for this input voltage range.
- During light load conditions, the average output voltage may reach 3.5 V with peaks not exceeding 3.42 V.
- TBT\_OUT load current flows from the TBT\_OUT pin when the device is in charge pump mode and pulls the buck converter inductor when the device is in buck mode.
- TBT\_OUT load current will not go higher than 50mA until after the device asserts HV\_OK.
- The maximum current supplied by the TPS65980 to all outputs is limited to 3.5 A. Max power depends on the Thunderbolt™ system and how much power is supplied to the input.
- A monotonicity of 0 mV means that the output does not have a negative going ramp at anytime during its power up ramp. A ripple of up to 62 mV from the DC/DC will occur.

## Electrical Characteristics (continued)

Unless otherwise noted all specifications applies over the  $V_{TBT\_IN}$  range and operating ambient temperature of  $-40^{\circ}\text{C} \leq T_A \leq 85^{\circ}\text{C}$ ,  $C_{TBT\_IN} = 22\text{ }\mu\text{F}$ ,  $C_{TBT\_OUT} = 10\text{ }\mu\text{F}$ ,  $C_{CBL\_OUT} = 1\text{ }\mu\text{F}$ ,  $C_{SS} = 10\text{ nF}$ , and  $33\text{ V}/\mu\text{s}$  logic input transitions. Typical values are for  $V_{TBT\_IN} = 12\text{ V}$  and  $T_A = 25^{\circ}\text{C}$ .

| PARAMETER                            | TEST CONDITIONS                                                                    | MIN  | TYP | MAX | UNIT               |
|--------------------------------------|------------------------------------------------------------------------------------|------|-----|-----|--------------------|
| <b>DEV_EN AND ILIMIT INPUT LOGIC</b> |                                                                                    |      |     |     |                    |
| $V_{IH}$                             | High-level input voltage                                                           | 2.6  |     |     | V                  |
| $V_{IL}$                             | Low-level input voltage                                                            |      |     | 0.6 | V                  |
| $I_{IN}$                             | Input leakage to GND<br>$V_{DEV\_EN} = 3.3\text{ V}$                               |      |     | 1   | mA                 |
| <b>RESET AND HV_OK OUTPUT LOGIC</b>  |                                                                                    |      |     |     |                    |
| $V_{OH}$                             | High-level output voltage<br>$I_L = -1.5\text{ mA}$ , Referenced to $V_{TBT\_OUT}$ | -250 |     | 0   | mV                 |
| $V_{OL}$                             | Low-level output voltage<br>$I_L = 1.5\text{ mA}$                                  | 0    |     | 250 | mV                 |
| <b>SOFT START<sup>(8)</sup></b>      |                                                                                    |      |     |     |                    |
| $I_{INRUSH}$                         | Inrush current di/dt                                                               |      |     | 250 | kA/s               |
| <b>THERMAL SHUTDOWN</b>              |                                                                                    |      |     |     |                    |
| $T_{SD}$                             | Shutdown temperature                                                               | 120  | 135 | 150 | $^{\circ}\text{C}$ |
| $T_{SDHYS}$                          | Shutdown hysteresis                                                                |      | 10  |     | $^{\circ}\text{C}$ |

(8) The charge pump will limit the normal ramp of current. Soft start will control the inrush current when the input ramps from 0 V to high voltage (not a normal operating condition). See recommended components section for required soft-start cap.

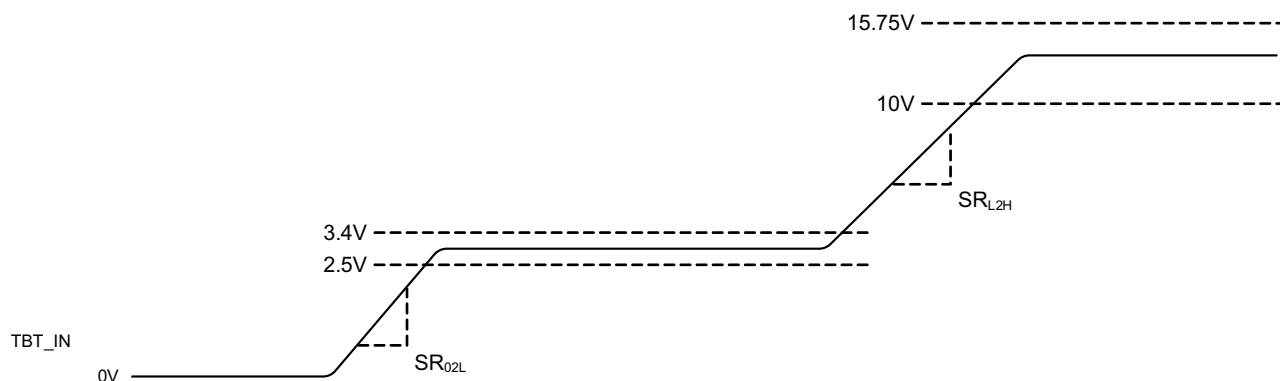
## 7.6 Timing Requirements

|                      |                                                                                                                                                                                                           | MIN | TYP | MAX | UNIT          |
|----------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----|-----|-----|---------------|
| $t_{IN2OR}$          | TBT_IN to TBT_OUT On Time<br>$V_{TBT\_IN} \geq 0.9 \times V_{TBT\_IN(min)}$ to<br>$V_{TBT\_OUT} \geq 0.99 \times V_{TBT\_OUT(min)}$<br>$R_{TBT\_OUT} = 100\text{ }\Omega$                                 |     |     | 20  | ms            |
| $t_{IN2OF}$          | TBT_IN to TBT_OUT Off Time<br>$V_{TBT\_IN} \leq 0.9 \times V_{TBT\_IN(min)}$ to<br>$V_{TBT\_OUT} \leq 0.1 \times V_{TBT\_OUT(min)}$<br>$R_{TBT\_OUT} = 100\text{ }\Omega$                                 |     | 2.4 | 4   | ms            |
| $t_{OUT2RR}$         | TBT_OUT to RESETZ High time<br>$V_{TBT\_OUT} \geq V_{REF\_RSTN(max)}$ rising to<br>$V_{RESET} = 0.9 \times V_{OH}$ , $C_{RESETN} = 100\text{ pF}$                                                         |     |     | 20  | $\mu\text{s}$ |
| $t_{IN2RF}$          | TBT_IN to RESETZ Low time<br>$V_{TBT\_IN} \leq 0.9 \times V_{TBT\_IN(min)}$ to<br>$V_{RESET} = 0.1 \times V_{OH}$ , $C_{RESETN} = 100\text{ pF}$                                                          |     |     | 20  | ms            |
| $t_{HV2OKR}$         | TBT_IN Rise to HV_OK<br>$V_{TBT\_IN} \geq V_{HVTR}$ to $V_{HV\_OK} = 0.9 \times V_{OH}$<br>$C_{HV\_OK} = 100\text{ pF}$                                                                                   |     |     | 10  | $\mu\text{s}$ |
| $t_{HV2OKF}$         | TBT_IN Fall to HV_OK<br>$V_{TBT\_IN} \leq V_{HVTR} - V_{HVTHYST}$ to<br>$V_{HV\_OK} = 0.1 \times V_{OH}$ , $C_{HV\_OK} = 100\text{ pF}$                                                                   |     |     | 10  | $\mu\text{s}$ |
| $t_{HV2CR}^{(1)(2)}$ | HV_OK to CBL_OUT On time<br>$V_{HV\_OK} \geq 1.65\text{ V}$ to $V_{CBL\_OUT} = 2.95\text{ V}$<br>$R_{CB\_OUT} = 100\text{ }\Omega$ , $C_{HV\_OK} = 100\text{ pF}$                                         | 0.1 |     | 10  | ms            |
| $t_{HV2CF}$          | HV_OK to CBL_OUT Off time<br>$V_{HV\_OK} \leq 1.65\text{ V}$ to $V_{CBL\_OUT} = 2.95\text{ V}$<br>$R_{CB\_OUT} = 100\text{ }\Omega$ , $C_{HV\_OK} = 100\text{ pF}$                                        |     |     | 40  | $\mu\text{s}$ |
| $t_{RCBL}$           | CABLE_OUT Ramp time<br>$V_{CBL\_OUT}$ ramp 10% to 90%<br>$C_{CBL\_OUT} = 0$ to $52\text{ }\mu\text{F}$                                                                                                    | 0.1 |     | 10  | ms            |
| $t_{DEVEN}$          | $\overline{\text{DEV\_EN}}$ to DEV_OUT On time<br>$V_{DEV\_EN} \leq 1.65\text{ V}$ to $V_{DEV\_OUT} = 2.7\text{ V}$<br>$R_{DEV\_OUT} = 100\text{ }\Omega$                                                 | 0.1 |     | 10  | ms            |
| $t_{DEVDIS}$         | $\overline{\text{DEV\_EN}}$ to DEV_OUT Off time<br>$V_{DEV\_EN} \geq 1.65\text{ V}$ to $V_{DEV\_OUT} = 2.7\text{ V}$<br>$R_{DEV\_OUT} = 100\text{ }\Omega$                                                |     |     | 50  | ms            |
| $t_{HV2DEVEN}$       | Wait time from HV_OK High before<br>$\overline{\text{DEV\_EN}}$ can be asserted low <sup>(2)</sup><br>$V_{HV\_OK} \geq 1.65\text{ V}$ to $V_{DEV\_EN} \leq 1.65\text{ V}$<br>$C_{HV\_OK} = 100\text{ pF}$ | 2   |     |     | ms            |

(1) TBT\_IN must transition from 3.3 V to high voltage, not from 0 V to high voltage

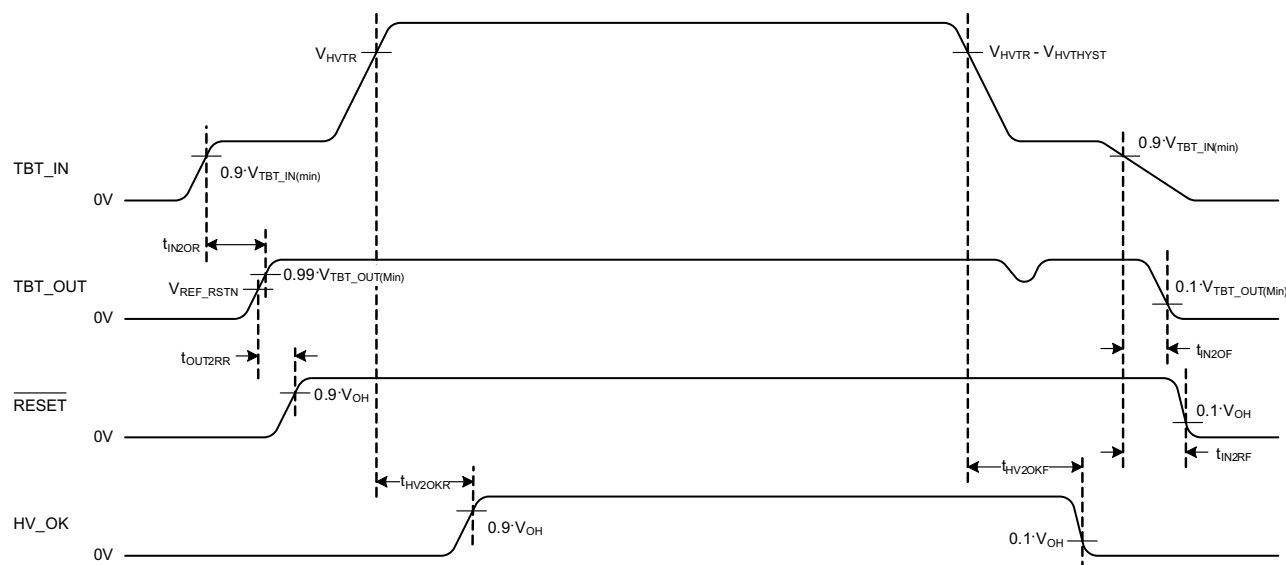
(2) During the transition from low voltage input to high voltage input, the total load of all outputs combined can not exceed 85 mA until 2 ms after HV\_OK asserts high.

## 7.7 Timing Diagrams



**Figure 1. TBT\_IN Slew Rates**

The TPS65980 has two normal operating regions. The first region is when  $2.5\text{ V} \leq V_{\text{TBT\_IN}} \leq 3.4\text{ V}$ . This is the normal power-up state and is termed the low-voltage state. When the input transitions to this range, the input slew rate must meet the  $\text{SR}_{02\text{L}}$  limits. In this voltage range, the TPS65980 operates with a charge pump to generate the nominally 3.3 V output. When the input voltage moves to the higher end of this range, the buck converter takes over to produce the 3.3 V. In normal operation, the TPS65980 input voltage will transition from the low-voltage range to a high-voltage range where  $10\text{ V} \leq V_{\text{TBT\_IN}} \leq 15.75\text{ V}$ . This is the high-voltage state and is the state where the TPS65980 will operate most of the time. In this state, the device operates as a buck converter providing a nominally 3.3 V output. [Figure 1](#) shows the input voltage transitions and states.



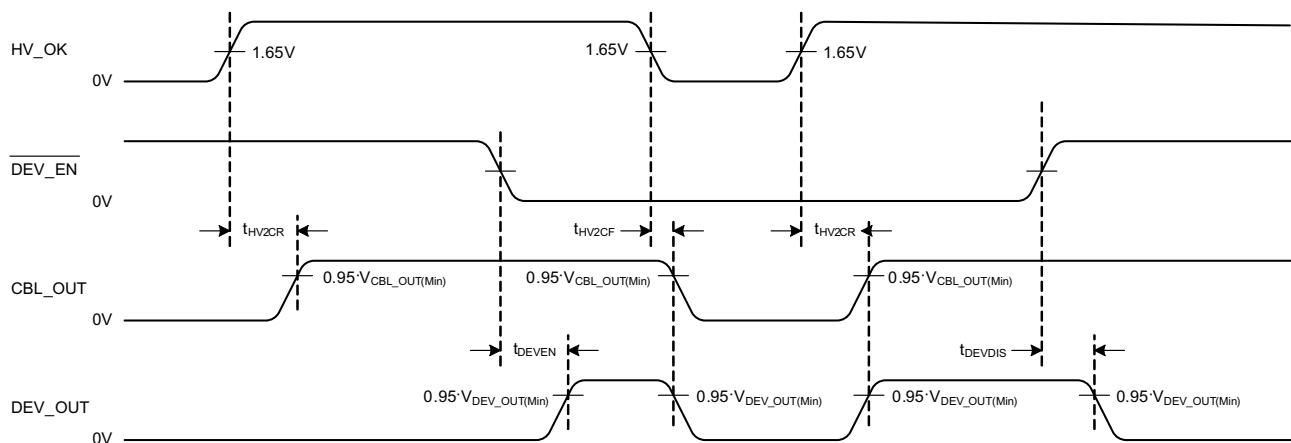
**Figure 2. Timing Diagram**

[Figure 2](#) shows normal operating timing diagram for the TBT\_OUT output voltage and the  $\overline{\text{RESET}}$  and HV\_OK output indicator signals. When TBT\_IN transitions to the low-voltage range, TBT\_OUT will power up a short time later. Once TBT\_OUT reaches the normal output range,  $\overline{\text{RESET}}$  will transition high. However, timing for  $\overline{\text{RESET}}$  is measured from the input TBT\_IN transitioning high. When TBT\_IN transitions from the low-voltage input range to the high-voltage input range, HV\_OK will transition high.  $\overline{\text{RESET}}$  is an active-high output indicating that the TBT\_OUT voltage is valid and. HV\_OK is an active-high output indicating that the TBT\_IN voltage is in the high-voltage range. When in the high-voltage state, the TPS65980 can provide much higher output current than when in the low-voltage state.



## Timing Diagrams (continued)

When the TBT\_IN input transitions from high-voltage to low-voltage, HV\_OK will de-assert to a logic low. When the TBT\_IN input voltage falls below the minimum operating voltage, the RESET output will de-assert low.



**Figure 3. Timing Diagram**

Figure 3 shows the CBL\_OUT and DEV\_OUT outputs and timing based on the HV\_OK signal and the DEV\_ENZ input. The CBL\_OUT output will be connected to TBT\_OUT and supplying 3.3V when HV\_OK is asserting high. The DEV\_OUT output will be connected to TBT\_OUT and supplying 3.3 V when HV\_OK is asserting high and the DEV\_ENZ input is low.

## 7.8 Typical Characteristics

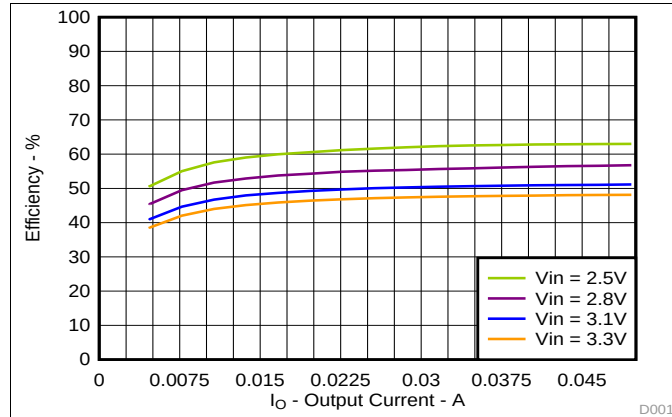


Figure 4. Low Voltage Efficiency

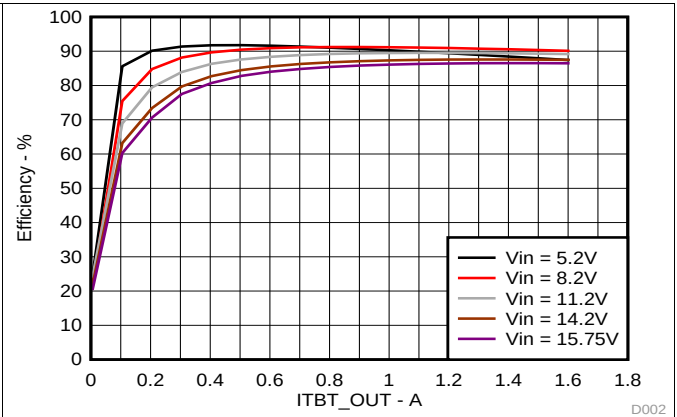


Figure 5. High Voltage Efficiency (System Sleep)

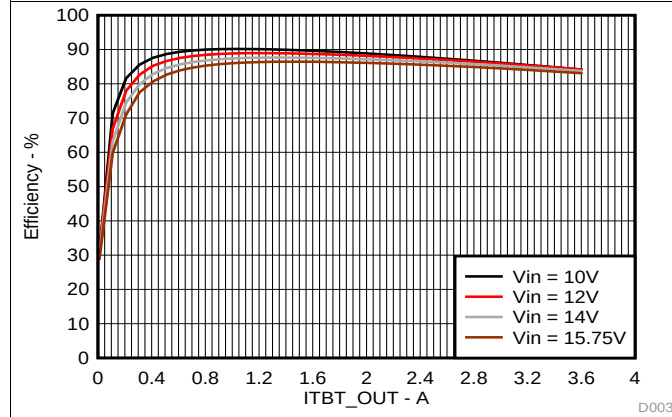


Figure 6. High Voltage Efficiency (Active)

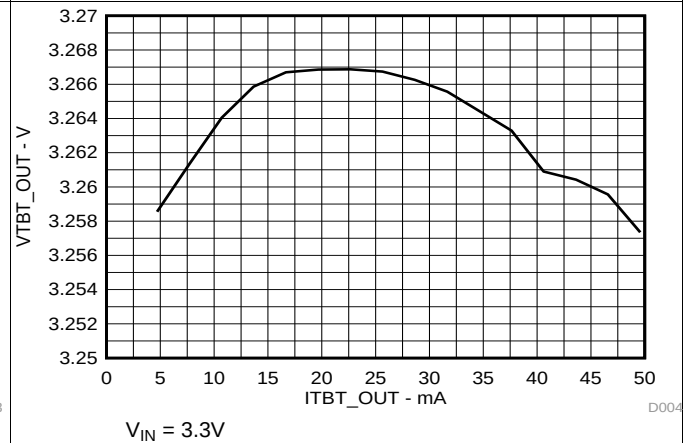


Figure 7. TBT\_OUT Load Regulation

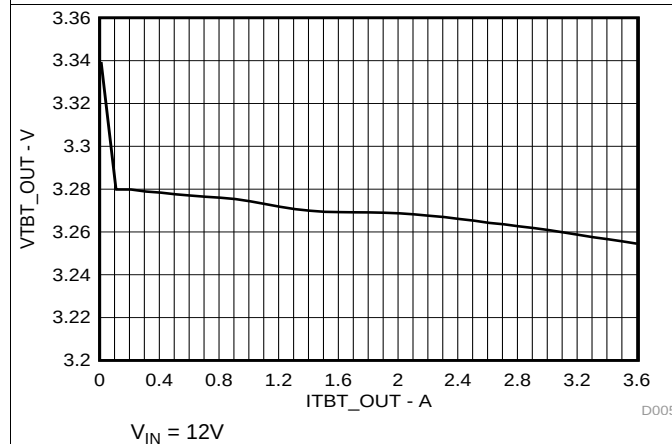


Figure 8. TBT\_OUT Load Regulation

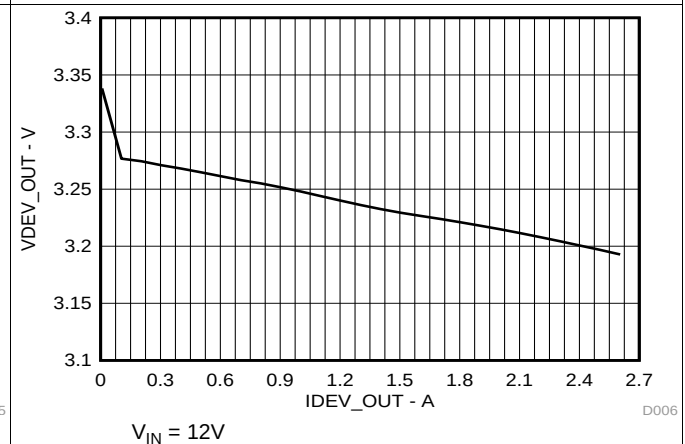
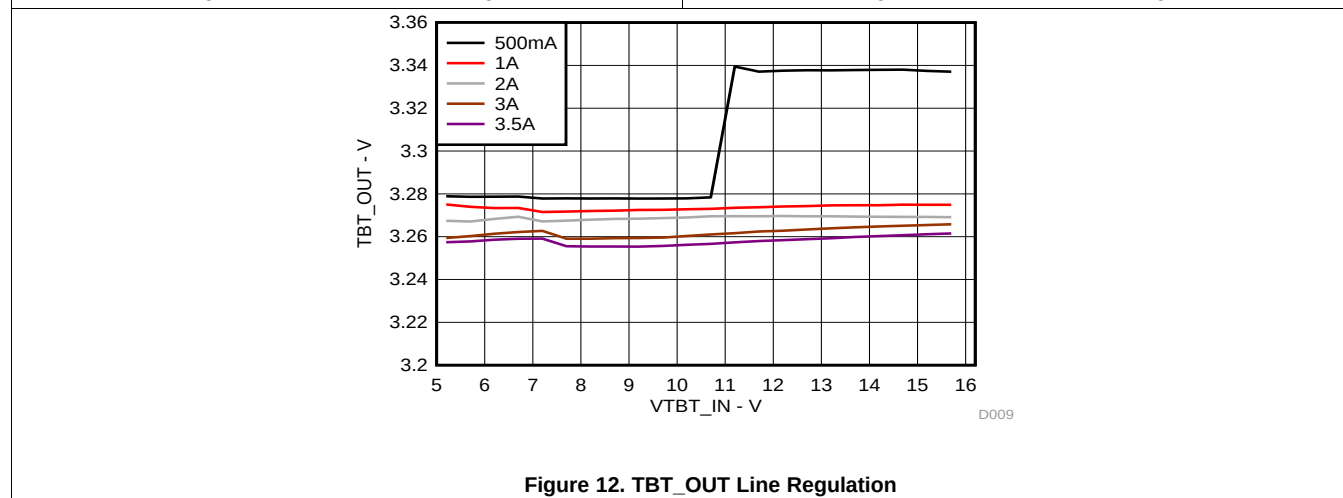
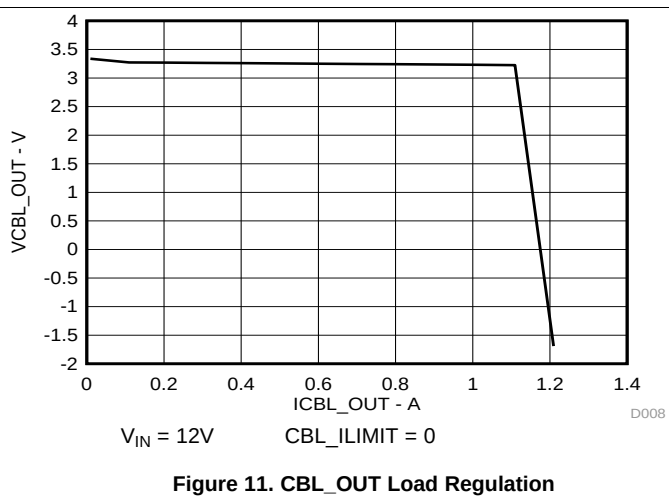
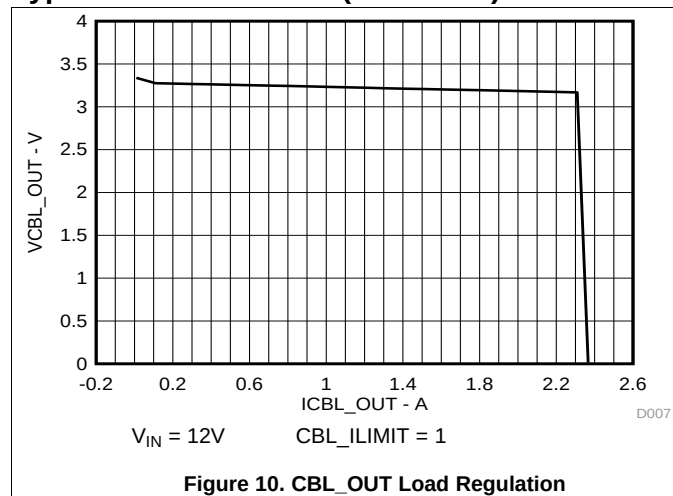


Figure 9. DEV\_OUT Load Regulation

## Typical Characteristics (continued)



## 8 Detailed Description

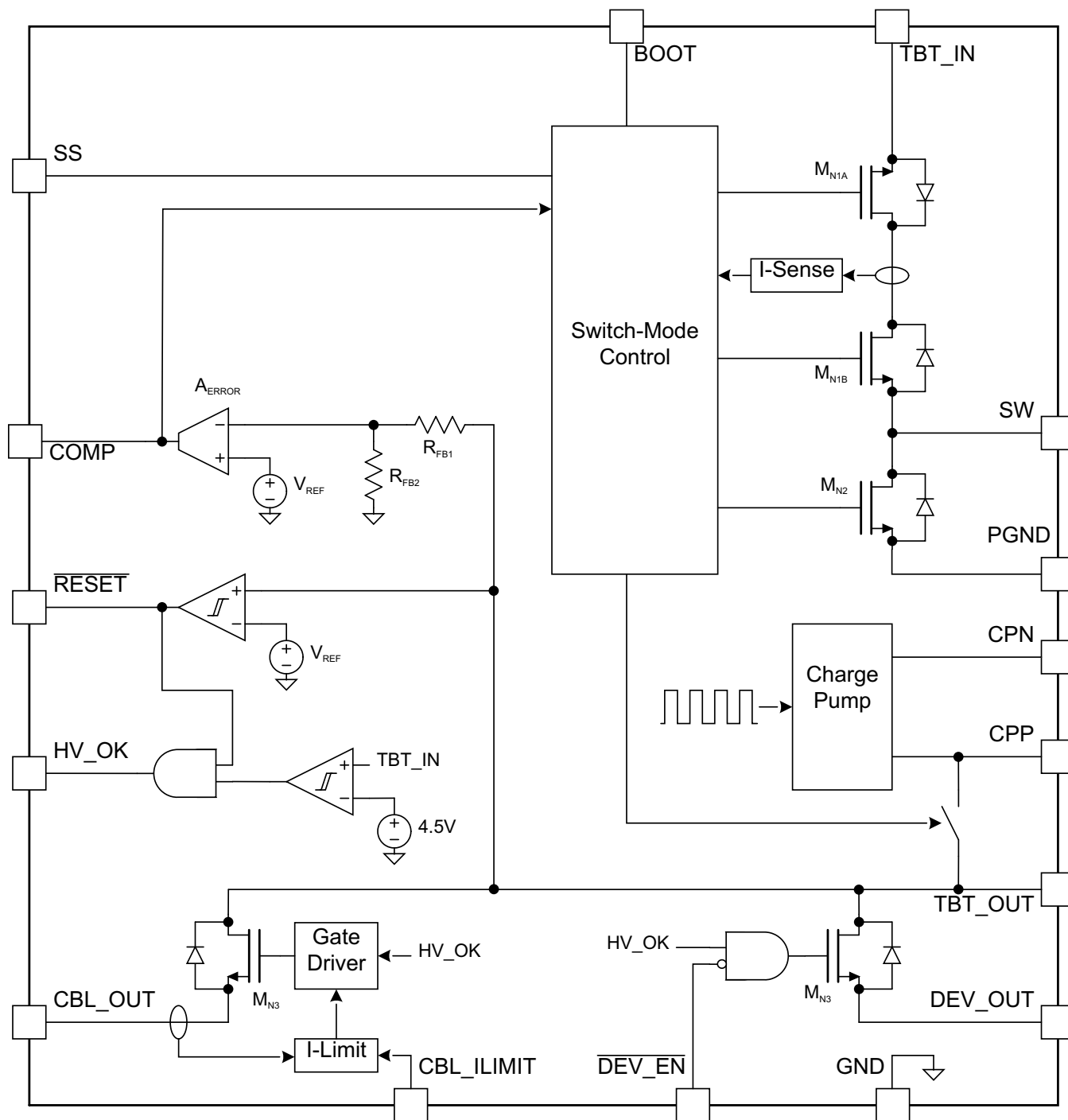
### 8.1 Overview

The TPS65980 is a switching regulator designed for Thunderbolt™ and Thunderbolt™ 2 bus-powered systems. The TPS65980 receives power from a Thunderbolt™ host in the range of 2.5 V to 15.75 V and produces three separate 3.3 V outputs. TBT\_OUT is the main output from the regulator. This output is generated from a switched-cap charge pump when the input is in the low-voltage range. The output is generated from a switching buck converter when the input voltage is in the high-voltage range. The TBT\_OUT output powers the local Thunderbolt™ controller and any additional Thunderbolt™ circuitry. Once in the input has settled in the high-voltage range, the other two outputs can be powered from the TBT\_OUT output. When the TBT\_OUT is supplying 3.3 V, the RESET output asserts high. When the TBT\_OUT voltage is below the valid output range, RESET asserts low. When TBT\_IN is in the high-voltage input range and RESET is asserting high (valid output), HV\_OK will assert high indicating that high-voltage has been received.

The CBL\_OUT output supplies power back to the Thunderbolt™ cable for powering the active cable circuitry. This output is connected to the TBT\_OUT output with a FET switch and is current limited.

The CBL\_ILIMIT logic input pin sets the current limit level. The DEV\_OUT output provides power to all other circuitry in the system. This output is not current limited and is enabled/disabled by the DEV\_EN logic input.

## 8.2 Functional Block Diagram



## 8.3 Feature Description

### 8.3.1 2.5-V to 15.75-V Input

The TPS65980 is powered from a Thunderbolt™ Bus. This is typically an input to a port from Thunderbolt™ cable. This input will start at 3.3 V ( $2.5\text{ V} \leq V_{\text{TBT\_IN}} \leq 3.4\text{ V}$ ) until a link is established between a host and the peripheral device containing the TPS65980. Once the link is established, the voltage at the input can transition to a higher operating voltage ( $10\text{ V} \leq V_{\text{TBT\_IN}} \leq 15.75\text{ V}$ ).

### 8.3.2 3.3-V Outputs

The TPS65980 has three separate 3.3 V outputs. One output, TBT\_OUT, is the output from the buck/boost and the other outputs, CBL\_OUT and DEV\_OUT, are outputs that through load switches from TBT\_OUT.

The TBT\_OUT supply provides power to the local peripheral Thunderbolt™ controller and support circuitry. The CBL\_OUT supply provides power back to the Thunderbolt™ cable and has adjustable current limit. The DEV\_OUT supply provides power to all other circuitry in the device to perform its designed function.

### 8.3.3 Thermal Shutdown

The TPS65980 has a thermal shutdown feature preventing the device from over heating during current limiting situations. The thermal shutdown occurs at a 135°C junction temperature typically. A 10°C hysteresis occurs before the thermal shutdown is cleared.

### 8.3.4 Cable Power Out Current Limit

The CBL\_OUT output is current limited internally. The current limit has two values which are set by the CBL\_ILIMIT logic input. When CBL\_ILIMIT = 0, the current limit will be set to 1.1 A typically. When CBL\_ILIMIT = 1, the current limit will be set to 2.2 A typically.

## 8.4 Device Functional Modes

### 8.4.1 Operation with $2.5\text{ V} \leq V_{\text{TBT\_IN}} \leq 3.4\text{ V}$

The TPS65980 has two normal operating regions. The first region is when  $2.5\text{ V} \leq V_{\text{TBT\_IN}} \leq 3.4\text{ V}$ . This is the normal power-up state and is termed the low-voltage state. When the input transitions to this range, the input slew rate must meet the SR02L limits. In this voltage range, the TPS65980 operates with a charge pump to generate the nominally 3.3 V output. When the input voltage moves to the higher end of this range, the buck converter takes over to produce the 3.3 V.

### 8.4.2 Operation with $10\text{ V} \leq V_{\text{TBT\_IN}} \leq 15.75\text{ V}$

In normal operation, the TPS65980 input voltage will transition from the low-voltage range to a high-voltage range where  $10\text{ V} \leq V_{\text{TBT\_IN}} \leq 15.75\text{ V}$ . This is the high-voltage state and is the state where the TPS65980 will operate most of the time. In this state, the device operates as a buck converter providing a nominally 3.3 V output.

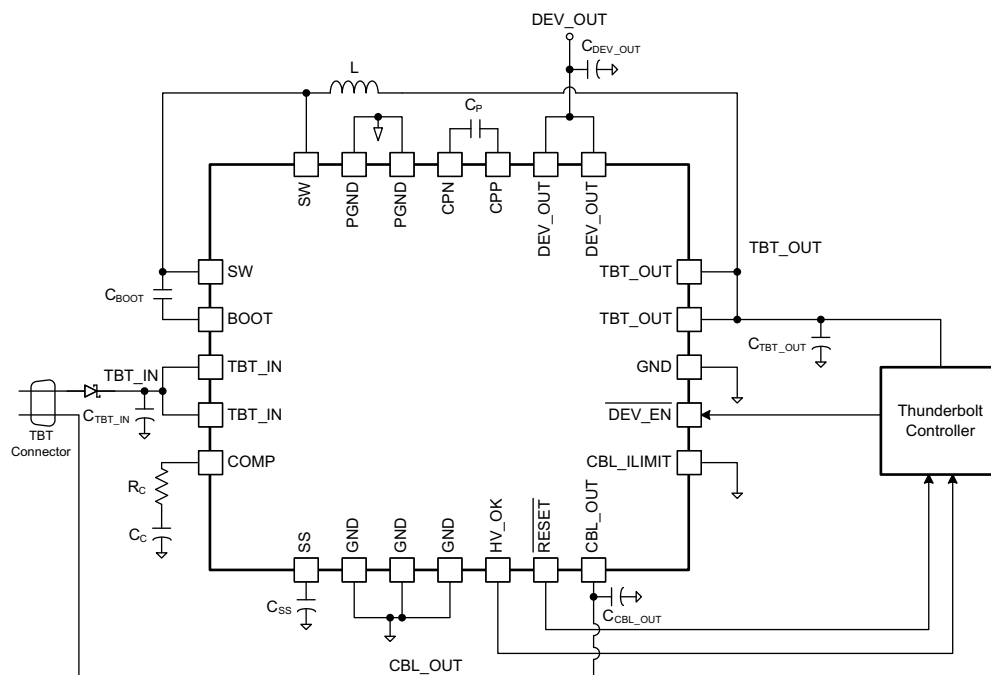
## 9 Application and Implementation

### 9.1 Application Information

The TPS65980 DC/DC switching regulator that receives power from a Thunderbolt™ or Thunderbolt™ 2 power bus ranging from 2.5 V to 15.75 V and generates three separate 3.3-V supply outputs.

### 9.2 Typical Application

#### 9.2.1 Single-Port Bus-Powered Thunderbolt™ Device



**Figure 13. Typical Application (Single-Port Bus-Powered Thunderbolt™ Device)**

##### 9.2.1.1 Design Requirements

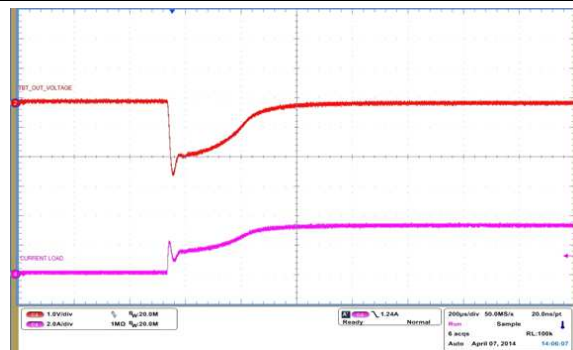
**Table 1. Recommended Component Values**

| COMPONENT         | DESCRIPTION                                           | MIN  | TYP | MAX | UNIT |
|-------------------|-------------------------------------------------------|------|-----|-----|------|
| C <sub>IN</sub>   | TBT_IN Input Capacitance                              | 17.6 | 22  | 52  | μF   |
| C <sub>BOOT</sub> | Converter Bootstrap Capacitance                       | 8    | 10  | 12  | nF   |
| C <sub>CP</sub>   | Charge Pump Capacitance (ceramic with ESR ≤ 10 mΩ)    | 0.8  | 1   | 1.2 | μF   |
| C <sub>SS</sub>   | Soft Start Capacitance                                | 8    | 10  | 12  | nF   |
| C <sub>TBT</sub>  | TBT_OUT Output Capacitance (ceramic with ESR ≤ 10 mΩ) | 16   | 20  | 24  | μF   |
| C <sub>CBL</sub>  | CBL_OUT Output Capacitance (ceramic with ESR ≤ 10 mΩ) | 0.8  | 1   | 1.2 | μF   |
| C <sub>DEV</sub>  | DEV_OUT Output Capacitance (ceramic with ESR ≤ 10 mΩ) | 0.8  | 1   | 1.2 | μF   |
| C <sub>C</sub>    | Compensation Capacitance                              | 8    | 10  | 12  | nF   |
| R <sub>C</sub>    | Compensation Resistance                               | 8    | 10  | 12  | kΩ   |
| L                 | Inductor SRR1280 (ESR ≤ 20 mΩ)                        | 8    | 10  | 12  | μH   |

##### 9.2.1.2 Detailed Design Procedure

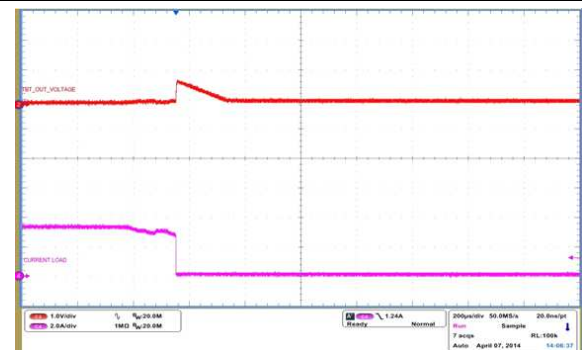
The TPS65980 should use the recommended component values in [Table 1](#). The device is designed to fit the needs of a Thunderbolt™ bus powered peripheral and the recommended component values are chosen to satisfy those conditions. The input capacitance C<sub>IN</sub> can be as high as 52 μF, but this maximum capacitance must include all capacitances seen at the input to the Thunderbolt™ port.

### 9.2.1.3 Application Performance Plots



$C_{TBT\_OUT} = 10 \mu F$   $V_{TBT\_IN} = 12 V$

**Figure 14. TBT\_OUT Load Transient Response (0.5A to 3.5A Step)**



$C_{TBT\_OUT} = 10 \mu F$   $V_{TBT\_IN} = 12 V$

**Figure 15. TBT\_OUT Load Transient Response (3.5A to 0.5A Step)**



**Figure 16. 0V to 3.3V Power Up With 50mA Load**



**Figure 17. 3.3V to 0V Power Down With 50mA Load**



**Figure 18. 3.3V to 15.75V Vin Step With 50mA Load**



**Figure 19. 15.75 to 3.3V Vin Step With 50mA Load**





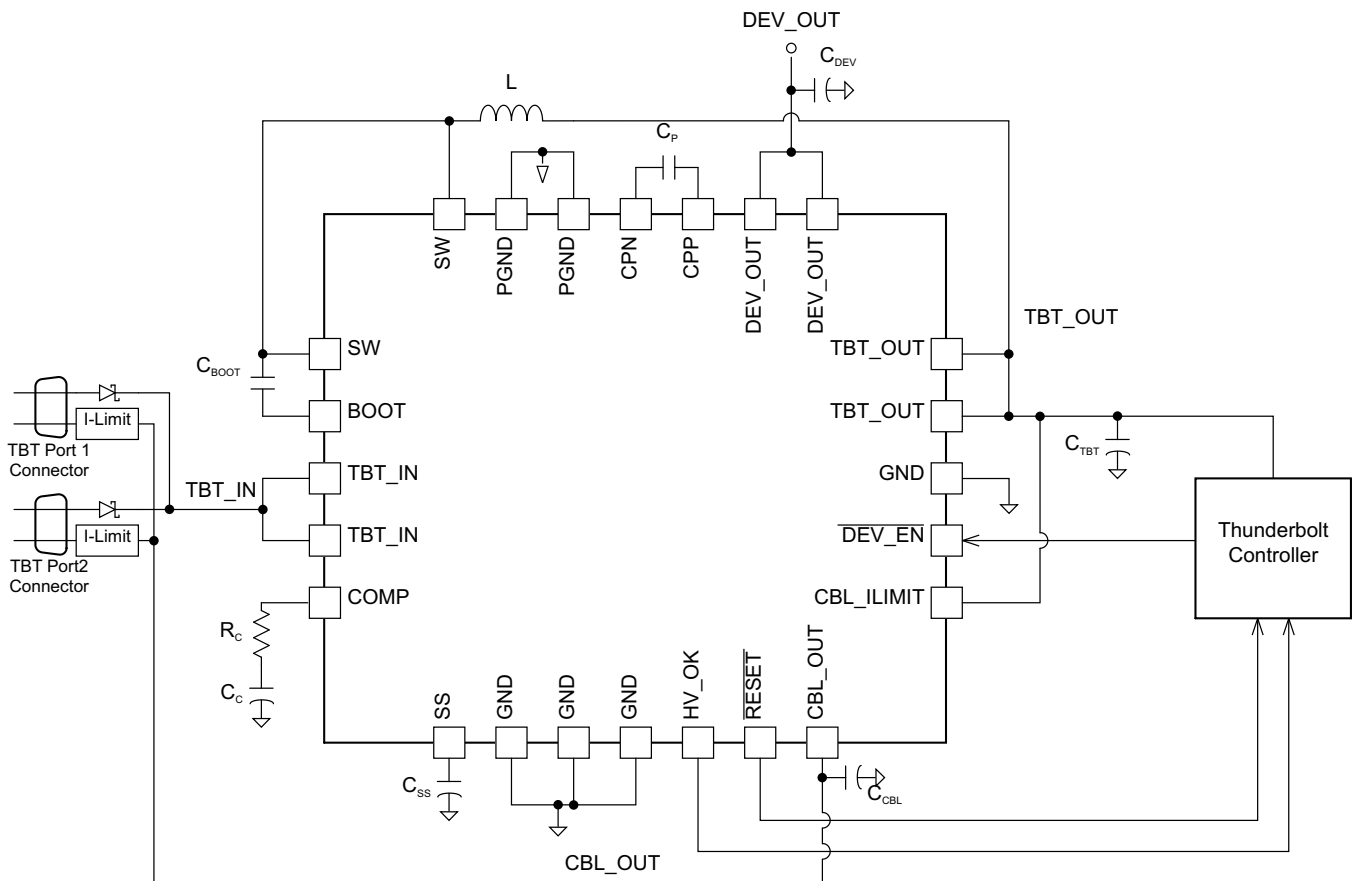
CBL\_ILIMIT = 0

**Figure 20. Short Circuit Current Limit Response**



CBL\_ILIMIT = 1

**Figure 21. Short Circuit Current Limit Response**



**Table 2. Recommended Component Values**

| COMPONENT         | DESCRIPTION                                           | MIN  | TYP | MAX | UNIT |
|-------------------|-------------------------------------------------------|------|-----|-----|------|
| C <sub>IN</sub>   | TBT_IN Input Capacitance                              | 17.6 | 22  | 52  | μF   |
| C <sub>BOOT</sub> | Converter Bootstrap Capacitance                       | 8    | 10  | 12  | nF   |
| C <sub>CP</sub>   | Charge Pump Capacitance (ceramic with ESR ≤ 10 mΩ)    | 0.8  | 1   | 1.2 | μF   |
| C <sub>SS</sub>   | Soft Start Capacitance                                | 8    | 10  | 12  | nF   |
| C <sub>TBT</sub>  | TBT_OUT Output Capacitance (ceramic with ESR ≤ 10 mΩ) | 16   | 20  | 24  | μF   |
| C <sub>CBL</sub>  | CBL_OUT Output Capacitance (ceramic with ESR ≤ 10 mΩ) | 0.8  | 1   | 1.2 | μF   |
| C <sub>DEV</sub>  | DEV_OUT Output Capacitance (ceramic with ESR ≤ 10 mΩ) | 0.8  | 1   | 1.2 | μF   |
| C <sub>C</sub>    | Compensation Capacitance                              | 8    | 10  | 12  | nF   |
| R <sub>C</sub>    | Compensation Resistance                               | 8    | 10  | 12  | kΩ   |
| L                 | Inductor SRR1280 (ESR ≤ 20 mΩ)                        | 8    | 10  | 12  | μH   |

### 9.2.2.2 Detailed Design Procedure

Refer to [Detailed Design Procedure](#) in the [Single-Port Bus-Powered Thunderbolt™ Device](#) section.

### 9.2.2.3 Application Performance Plots

Refer to [Application Performance Plots](#) in the [Single-Port Bus-Powered Thunderbolt™ Device](#) section.

## 10 Power Supply Recommendations

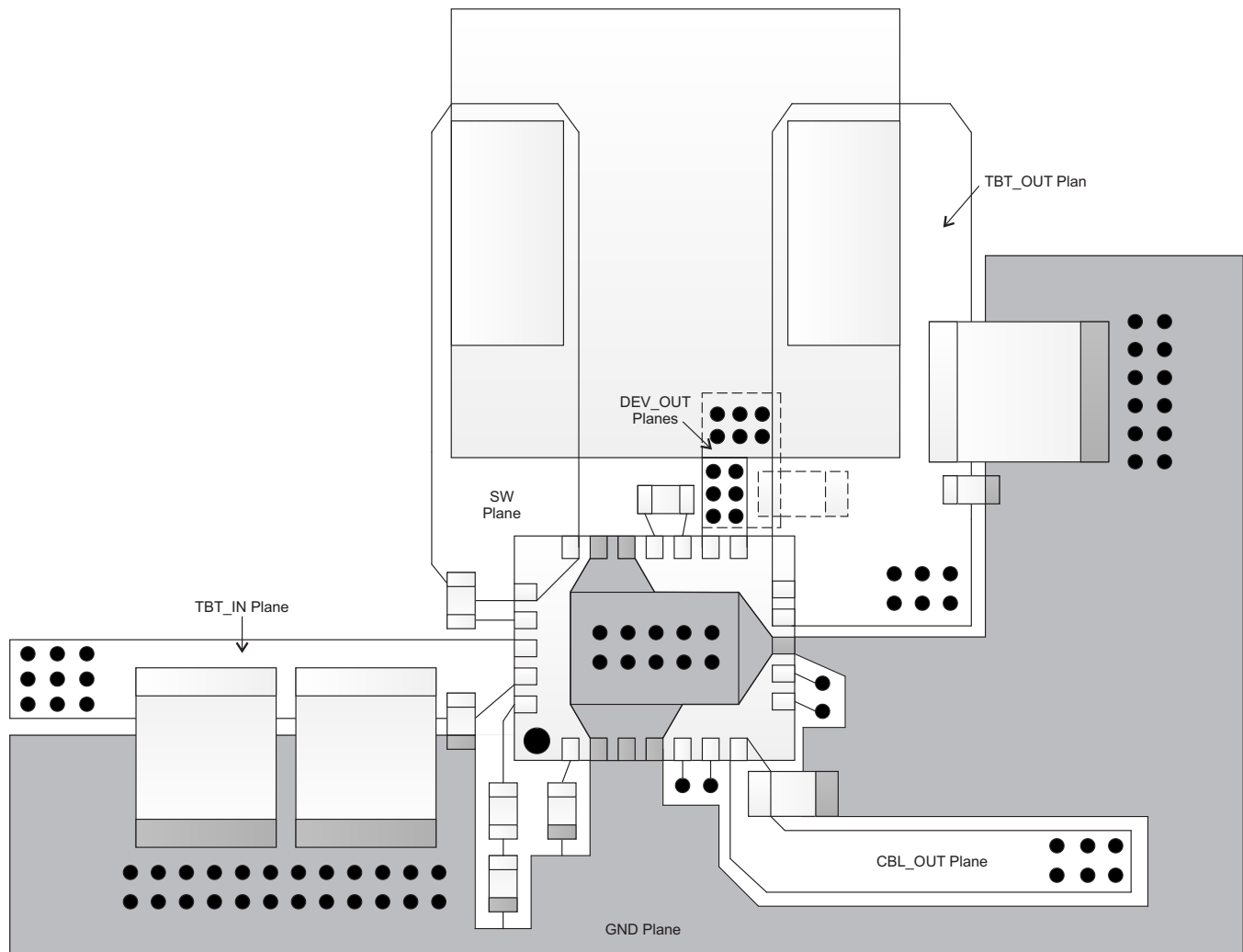
The TPS65980 is designed to operate from a Thunderbolt™ bus. The input will range from 2.5 V to 15.75 V. The input should be placed as near to the port connector as possible.

## 11 Layout

### 11.1 Layout Guidelines

Proper placement and routing will maximize the performance of the TPS65980. Follow [Figure 23](#) for optimized layout and routing (hashed planes indicate bottom layer).

### 11.2 Layout Example



**Figure 23. Top View Board Layout**

## Layout Example (continued)

For TBT\_IN, the input capacitors must be placed close to the device with an inductance less than 1nH from input capacitors to the TBT\_IN pins. Layout tools and calculators are available to approximate the inductance. The input capacitors must have their GND side area via stitched to the GND plane. The GND side of the input cap should also share the same polygon as the PGND/PowerPad on the top layer. PowerPad should be connected to the GND plane through multiple vias.

Inductor placement should be above the TPS65980, slightly to the left of the device. The SW pins to the inductor must be connected through a plane as shown in Figure 23. The TBT\_OUT pins also have to be connected to the other side of the inductor with a plane. This plane should be wide to overlap the output capacitors. The GND side of the output capacitors should be stitched to the GND plane.

The CBL\_OUT output capacitor should be placed close to the device on the top layer with an inductance less than 1 nH from the capacitor to the CBL\_OUT pin. The DEV\_OUT capacitor is best placed on the bottom side of the board with two planes (top and bottom) connect through a set of vias. The number of vias placed should be able to carry at least 3 A (DEV\_OUT = 2.5 A max) for margin and inductance path less than 1nH from DEV\_OUT pins to capacitor. When routing DEV\_OUT to an internal power plane, follow Figure 24 for via paths.

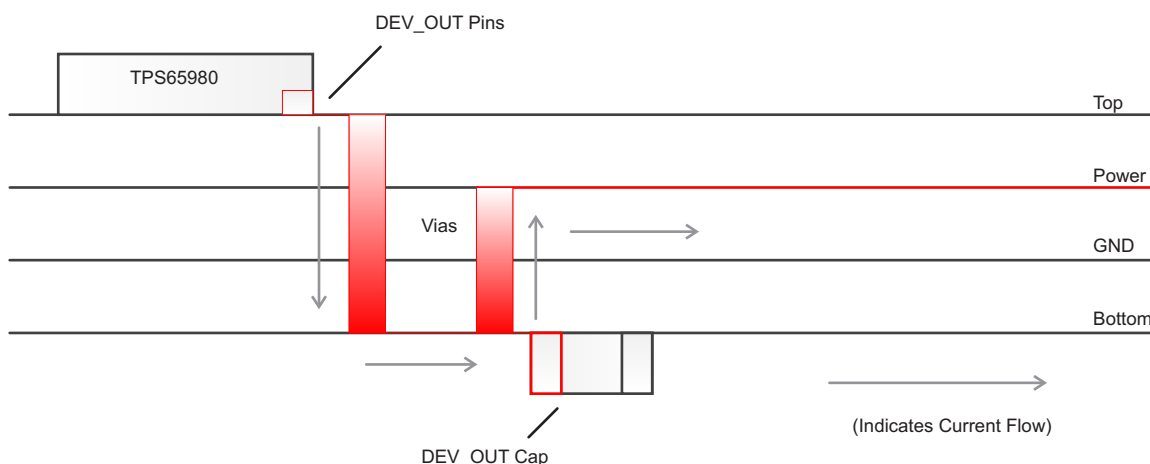


Figure 24. DEV\_OUT Recommended Routing

The charge pump capacitor must be placed on the top layer close to the CPP and CPN pins. The inductance paths from capacitor to the pins must be less than 1 nH. SS and Compensation components should be placed on the top layer close to the device.

## 12 器件和文档支持

### 12.1 Trademarks

Thunderbolt is a trademark of Intel Corporation.

### 12.2 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

### 12.3 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms and definitions.

## 13 机械封装和可订购信息

以下页中包括机械封装和可订购信息。 这些信息是针对指定器件可提供的最新数据。 这些数据会在无通知且不对本文档进行修订的情况下发生改变。 欲获得该数据表的浏览器版本，请查阅左侧的导航栏。

## PACKAGING INFORMATION

| Orderable part number        | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|------------------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">TPS65980RHFR</a> | Active        | Production           | VQFN (RHF)   24 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | TPS<br>65980        |
| TPS65980RHFR.A               | Active        | Production           | VQFN (RHF)   24 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | TPS<br>65980        |
| <a href="#">TPS65980RHFT</a> | Active        | Production           | VQFN (RHF)   24 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | TPS<br>65980        |
| TPS65980RHFT.A               | Active        | Production           | VQFN (RHF)   24 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | TPS<br>65980        |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

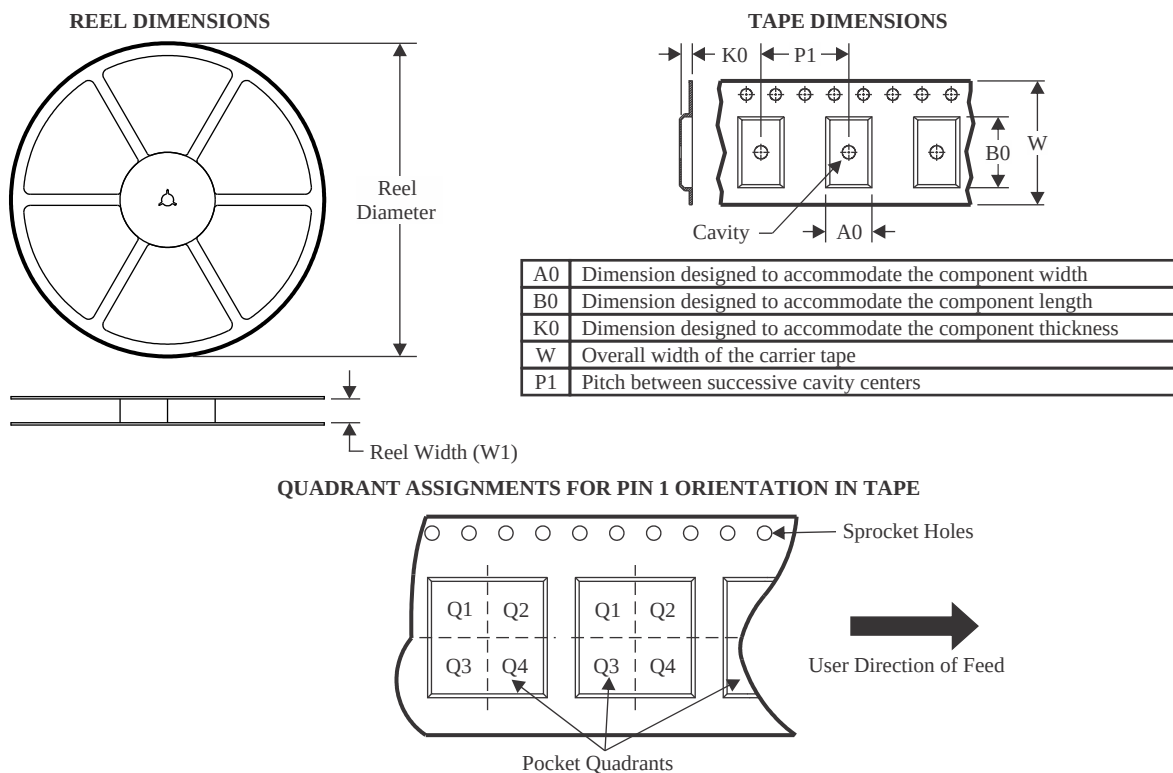
**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.





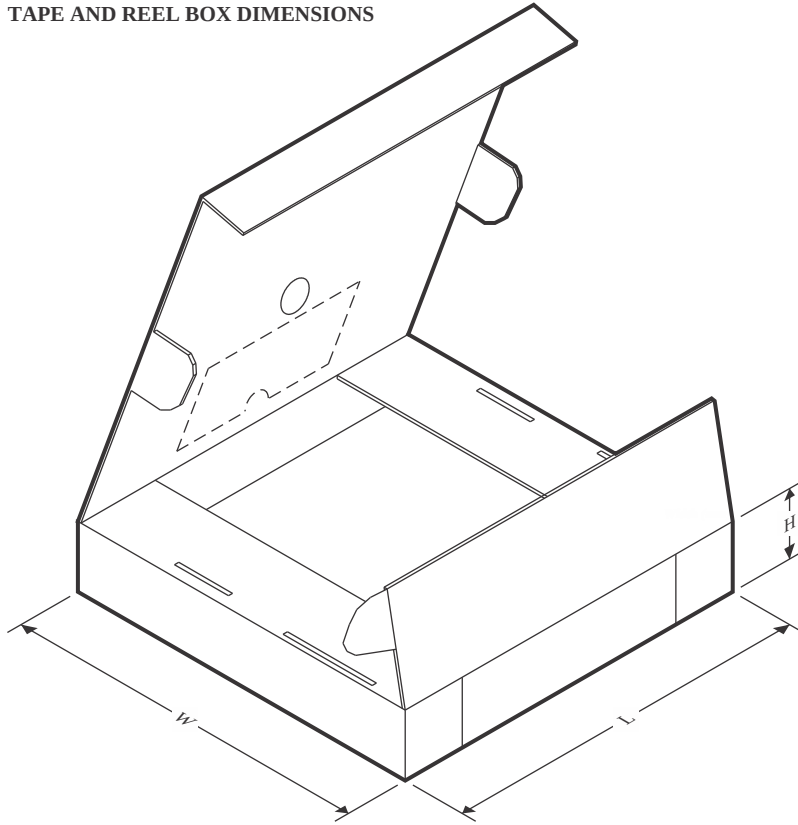
## TAPE AND REEL INFORMATION



\*All dimensions are nominal

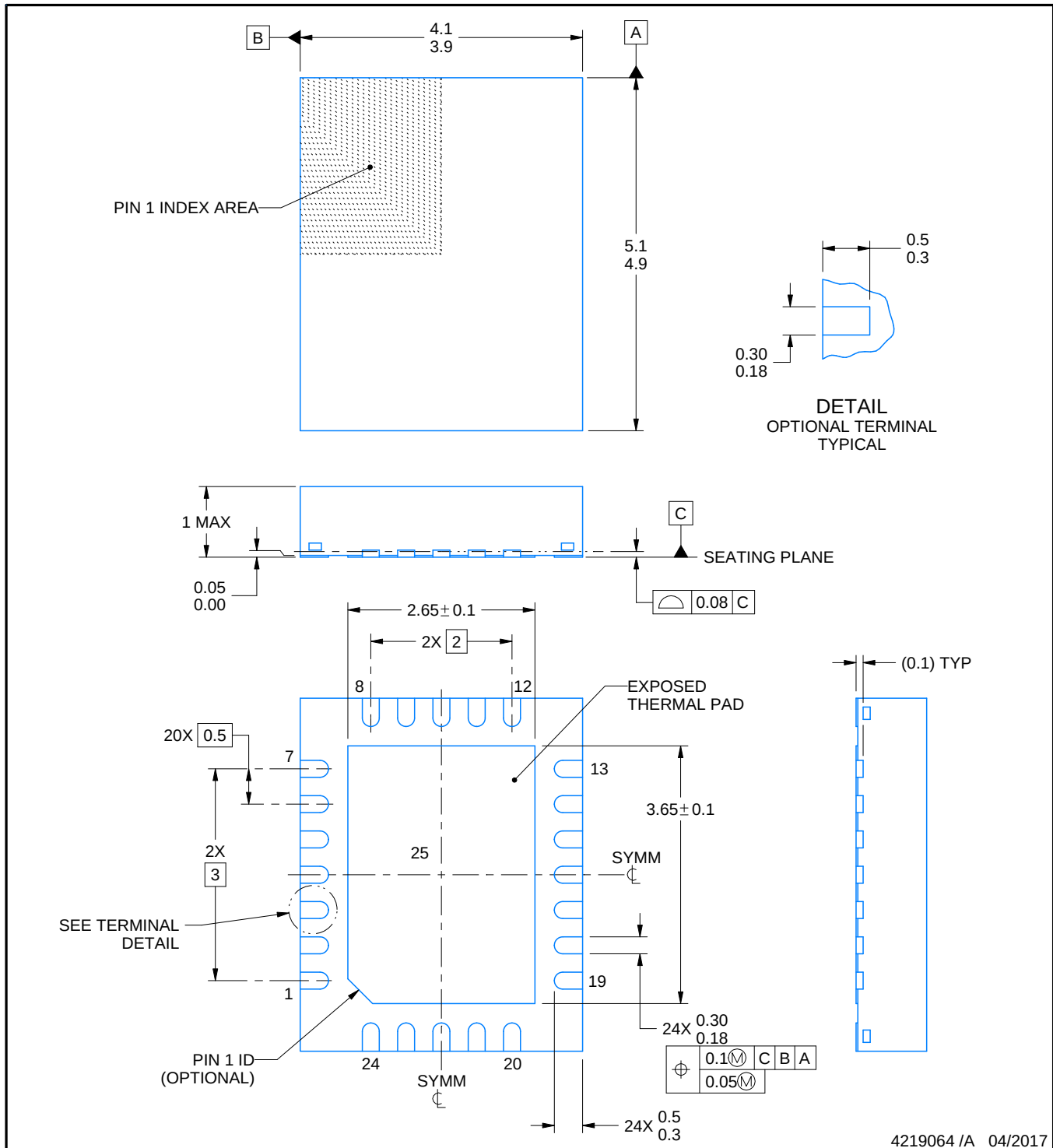
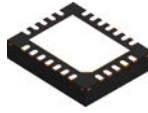
| Device       | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| TPS65980RHFR | VQFN         | RHF             | 24   | 3000 | 330.0              | 12.4               | 4.3     | 5.3     | 1.3     | 8.0     | 12.0   | Q1            |
| TPS65980RHFT | VQFN         | RHF             | 24   | 250  | 180.0              | 12.4               | 4.3     | 5.3     | 1.3     | 8.0     | 12.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TPS65980RHFR | VQFN         | RHF             | 24   | 3000 | 346.0       | 346.0      | 33.0        |
| TPS65980RHFT | VQFN         | RHF             | 24   | 250  | 210.0       | 185.0      | 35.0        |



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## NOTES:

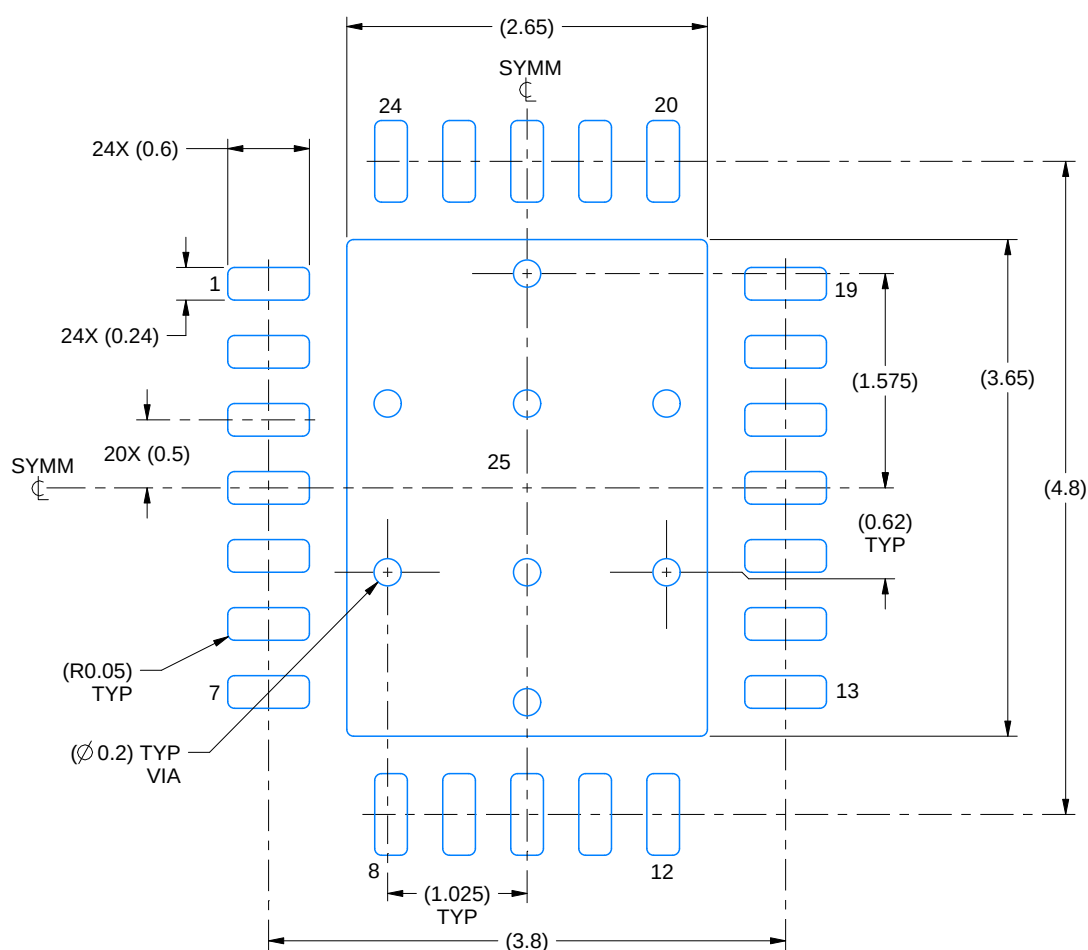
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

# EXAMPLE BOARD LAYOUT

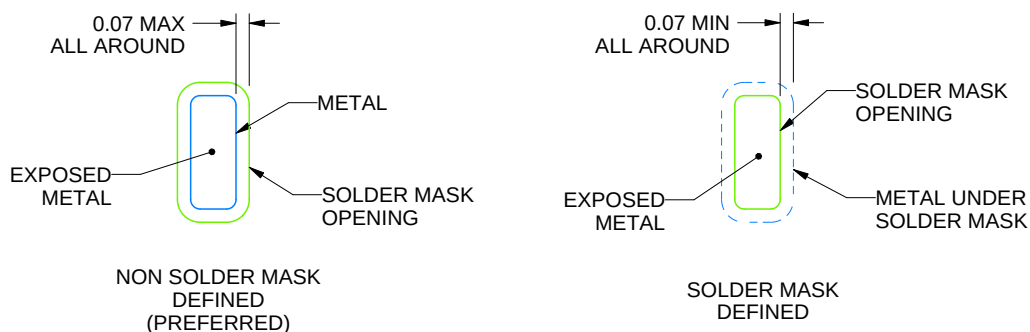
RHF0024A

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:18X



SOLDER MASK DETAILS

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NOTES: (continued)

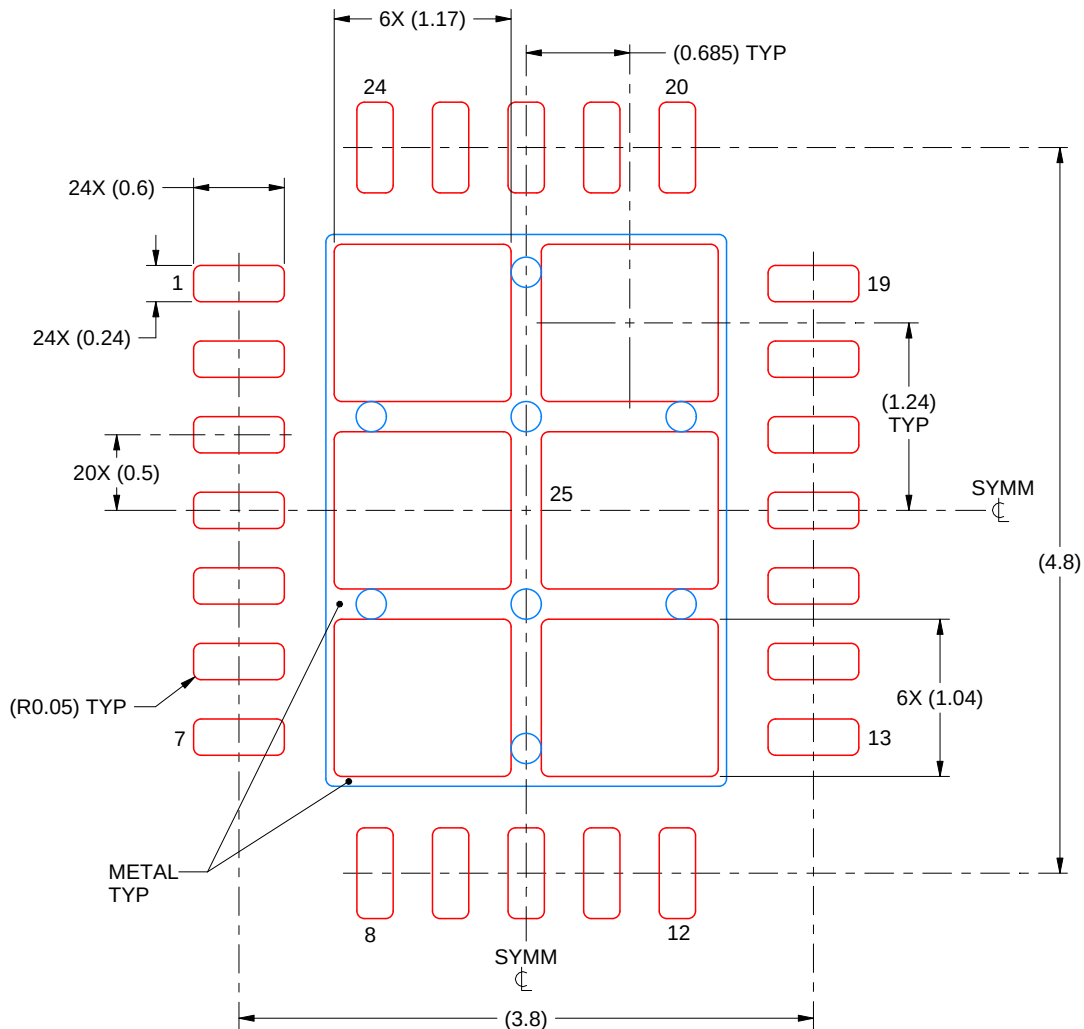
- This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 ([www.ti.com/lit/sluea271](http://www.ti.com/lit/sluea271)).
- Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

# EXAMPLE STENCIL DESIGN

RHF0024A

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



**SOLDER PASTE EXAMPLE**  
BASED ON 0.125 mm THICK STENCIL

EXPOSED PAD 25  
75% PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE  
SCALE:20X

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NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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